Electronic Patent Application Fee Transmittal							
Application Number:	10678855						
Filing Date:	03-Oct-2003						
Title of Invention:	DICING/DIE-BONDING FILM, METHOD OF FIXING CHIPPED WORK AND SEMICONDUCTOR DEVICE						
First Named Inventor/Applicant Name:	Takeshi Matsumura						
Filer:	Kerry S. Taylor/Chiaki Kokka						
Attorney Docket Number:	UNIU79.014AUS						
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Certificate of correction		1811	1	100	100		
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			100